000	aterial Composit Copyright 2005. IPC, I ernational and Pan-Am	Bannockbi	urn, Illinois. A	ll rights reserved untions.	under both	This docum level parts,	ent is a decla the declaratio	ration of t n encomp	he substance asses all low	s within the manufa er level materials fo	cturer listed	d item. Note: it e manufacturer	the item is an a has engineering	ssembly with lower responsibility.	
					Form Type Distribute					terials and	rials and Mfg Information				
Supplier Information	n														
Company name*			Company unique ID			Unique ID Authority				Respo	Response Date*				
onsemi											2024-0	2024-04-24			
Contact Name			Title - Contact			Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com				
Authorized Representative* Tit			Title - Repres	Title - Representative			Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards P			Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com				
Requester Item	Requester Item Number Mfr Iten		Number Mfr Item Name				Effective D	ate Vers	sion Manufacturing Site			Weight*	UOM	Unit Type	
		FDMS86180		FET 100V 3.2 mOhm PQFN56			2024-04-24			РВВ		122.135765	mg	Each	
Manufacturing Proc	cess Information	L		-								-			
Terminal Plating / Grid Array Material Termin		erminal Base A	Base Alloy J-STD-020 MSL		L Rating	Peak P	k Process Body Temperatu		ure Max Time at Peak Tempera		mperature Number of Reflow Cycles		cles		
Matte Tin (Sn) - annealed CU Allo			U Alloy	1			260 C 30			sec	seconds 3				
Comments															
level 1 - maximum time at	t peak temperature d	uring sole	dering is 10-3	0 seconds											
For more information reg	arding material com	position p	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	19.1	mg	Supplier	Zinc (Zn)	7440-66-6		0.025	mg
			Supplier	Iron (Fe)	7439-89-6		0.458	mg
			Supplier	Copper (Cu)	7440-50-8		18.617	mg
Die	2.54	mg	Supplier	Silicon (Si)	7440-21-3		2.54	mg
Die Attach Solder	3.017	mg	Supplier	Silver (Ag)	7440-22-4		0.0754	mg
			А	Lead (Pb)	7439-92-1	7a	2.7907	mg
			Supplier	Tin (Sn)	7440-31-5		0.1508	mg
Lead Frame	46.436	mg	Supplier	Silver (Ag)	7440-22-4		0.636	mg
			Supplier	Zinc (Zn)	7440-66-6		0.06	mg
			Supplier	Iron (Fe)	7439-89-6		1.099	mg
			Supplier	Copper (Cu)	7440-50-8		44.641	mg
Mold Compound-Black	42.7	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.135	mg
			Supplier	Carbon Black (C)	1333-86-4		0.427	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.003	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.135	mg
Plating	8.33	mg	Supplier	Tin (Sn)	7440-31-5		8.33	mg
Wire Bond	0.012765	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0124	mg